

Combination High Speed Mezzanine

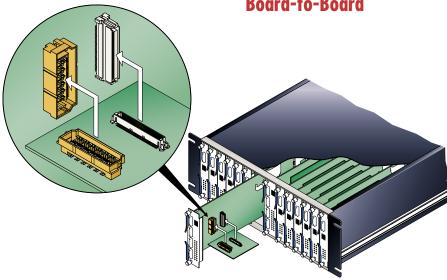
Combining Plateau HS Mezz and SlimStack stacking connectors optimizes performance and cost for high circuit count applications

Molex offers a significant cost reduction over competing products for high-circuit count board-to-board applications with the Combination High Speed Mezzanine solutions. Achieve superior electrical performance and signal speeds up to 10Gbps and beyond utilizing the differential-pair design of the Plateau HS Mezz system. At the same time, double up on circuit density and cost savings with the SlimStack family of mezzanine-style connectors for single-ended speeds up to 3Gbps.

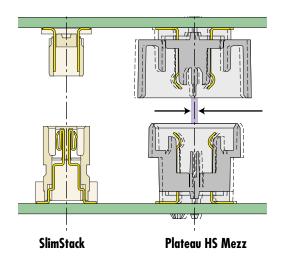
Plateau HS Mezz and SlimStack are well suited to work in tandem for a range of mezzanine applications. Connector designs provide generous lead-ins, allowing for maximum processing and mismating tolerances. Combinations of mated heights from 10.00 to 15.00mm (.354 to .591") and packaging styles are also available, including tubes and embossed tape with or without pick-and-place covers.

1.20mm (.047") Pitch Plateau HS Mezz™ High Speed Mezzanine

0.635mm (.025") Pitch SlimStack™ SMT Stacking Board-to-Board



Mezzanine card with HS Mezz and SlimStack for a cost effective solution using high-speed and lower-speed requirements.



Combination High Speed Mezzanine arrangement absorbs up to 0.1mm in mis-alignment in X and Y axis when 2 mating pairs are used.

Features and Benefits

Plateau HS Mezz

- Advanced gold-plated plastic housings with integrated shielding system support high-speed differential signaling in excess of 10Gbps
- Contacts on 1.20mm (.047") centerline pitch arranged in isolated differential pairs on 3.50mm (.138") pitch for controlled impedance
- Multiple stack heights from 10.00 to 25.00mm (.394 to .984") with circuit size ranging from 6 to 36 pairs (12 to 72 circuits)

SlimStack

- Contacts on 0.635mm (.025") centerline pitch support single-ended signal speeds up to 3Gbps
- Gold plated contacts with wide-angled mating surfaces to minimize risk of damage during mating
- Multiple stack heights from 6.00 to 16.00mm (.236" to .630") with circuit sizes ranging from 20 to 240 circuits for high-density design flexibility

APPLICATIONS

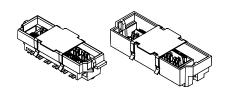
- Switches and Hubs
- Routers
- Servers and Blade Servers

- Workstations
- Storage Devices



Combination High Speed Mezzanine

Plateau HS Mezz



Electrical

Upper-End Speed: 10.0Gbps (6.8GHz)
No special S:G pattern needed
Impedance: 100 ± 10 ohms at 50 psec risetime
(10/90%) for all stack heights
Crosstalk: Less than 2% @ 50 psec
Current Rating: 1.5A per circuit

SlimStack



Electrical

Upper-End Speed: 3Gbps (2GHz) Single-ended 1:1 S:G pattern

Impedance: 64 ohms - 16.00mm (.630") stack height

Crosstalk: Less than 8% @ 50 psec Current Rating: 0.5A per circuit 1.20mm (.047") Pitch Plateau HS Mezz™ High Speed Mezzanine

0.635mm (.025") Pitch SlimStack™ SMT Stacking Board-to-Board

ORDERING INFORMATION

Mated Stack Height	Circuit Size		Plateau HS Mezz		SlimStack	
	Plateau HS Mezz	SlimStack	Plug	Receptacle	Plug	Receptacle.
10.00mm (.394")	12, 24, 48, 72	20, 40, 60, 80, 100, 120, 140, 160, 180, 200	75003-0X05	75005-0X04	53553	52760
						52885*
					53627*	52760
						52885*
12.00mm (.472")	12, 24	20 to 180	75003-0X05	75005-0X06	55091	52837
		40 to 80				52901*
13.00mm (.512")	12, 24	20 to 180	75003-0X08	75005-0X04	53481	52837
						52901*
					53625*	52837
						52901*
15.00mm (.591")	12, 24, 48, 72	40 to 140	75003-0X08 75003-0X10	75005-0X06 75005-0X04	53552	52837
						52901*
					53649*	52837
						52901*

*Embossed tape and reel packaging

Plateau HS Mezz Circuit Sizes					
X=3	12 circuit (6 pair)				
X=0	24 circuit (12 pair)				
X=1	48 circuit (24 pair)				
X=2	72 circuit (36 pair)				

Americas Headquarters Lisle, Illinois 60532 U.S.A. 1-800-78MOLEX amerinfo@molex.com Far East North Headquarters Yamato, Kanagawa, Japan 81-462-65-2324 feninfo@molex.com Far East South Headquarters Jurong, Singapore 65-6-268-6868 fesinfo@molex.com

Visit our Web site at http://www.molex.com

European Headquarters Munich, Germany 49-89-413092-0 eurinfo@molex.com Corporate Headquarters 2222 Wellington Ct. Lisle, IL 60532 U.S.A. 630-969-4550 Fax:630-969-1352